17.0" SXGA

High bright color TFT-LCD module

Model: CH170CLJL-HB2

Date: Jun. 16th, 2012

Note: This specification is subject to change without notice

Customer： _____
Date： _____

Approved	Prepared
Date:	Date:

.

Contents

RECORD OF REVISION

Version and Date	Page	Old description	New description	Remark
0.1 2012/06/16	All	First Edition for customer		

1. HANDLING PRECAUTIONS

1) Since front polarizer is easily damaged, pay attention not to scratch it.

2) Be sure to turn off power supply when inserting or disconnecting from input connector.

3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.

4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.

5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.

6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.

7) Do not open or modify the Module Assembly.

8) Do not press the reflector sheet at the back of the module to any directions.

9) In case if a Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of TFTLCD panel.

10) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.

11)After installation of the TFT Module into an enclosure, do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.

13)Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.

2. General Description

2.1, Overview

CH170CLJL-HB2 is a Color Active Matrix Liquid Crystal Display composed of a TFT-LCD display, a driver circuit, and a backlight system. The display supports the SXGA+ (1280(H) x 1024(V)) screen format and 16.7M colors (RGB 6-bits+Hi-RFC data).All input signals are 2 Channel LVDS interface compatible.

2.2 Features

- 1500nits high brightness
- LED backlight
- Wide operation temperature
- RoHS Compliance

2.3 Application

Industrial Application.

2.4 Display Specifications

| Items	Unit	Specification
Screen Diagonal	inch	17.0"
Active Area	mm	337.920(H) × 270.336(V)
Pixels H x V	pixels	1280 × 3(RGB) × 1024
Pixels Pitch	um	0.264(per one triad) × 0.264
Pixel Arrangement		RGB Vertical stripe
Display mode		TN mode, normally white
White luminance (center)	Cd/m^2	1500 (Typ.)
Contrast ratio		1000 (Typ.)
Optical Response Time	msec	5 ms (Typ. on/off)
Normal Input Voltage VDD	Volt	5.0
Power Consumption (VDD Line + LED L Line)	Watt	37.3 (Typ.)
Weight	Grams	2000 (Typ.)
Physical size	mm	358.5(H) x 296.5(V) Typ. x 15.8(D) Max.
Electrical Interface		2 Chanel LVDS
Support Colors		16.7M colors (RGB 6-bits +Hi-FRC data)
Surface Treatment		Anti-Glare, 3H
Temperature range		
Operating	^{0}C	-20 ~ 50 (LCD surface temperature)
Storage (Shipping)	^{0}C	-20 ~ 70
RoHS Compliance		RoHS Compliance

2.5 Optical Characteristics

The following optical characteristics are measured under stable condition at 25 ^{0}C

Items	Unit	Conditions	Min.	Typ.	Max.	Note
Viewing angle	Deg.	Horizontal (Right) CR=10 (Left)	160	170		2
		Vertical (Up) CR=10 (Down)	150	160		
Contrast Ratio		Normal Direction		1000		3
Response Time	msec	Raising time (T_{rR})		3.5		4
		Falling time (T_{rF})		1.5		
		Raising + Falling		5		
Color / Chromaticity Coordinates (CIE)		Red x	-0.04		+0.04	5
		Red y				
		Green x				
		Green y				
		Blue x				
		Blue y				
Color coordinates (CIE) White		White x		0.32		
		White y		0.36		
Center Luminance	Cd/m^2		1200	1500		6
Luminance Uniformity	%			70		7
Crosstalk (in 60 Hz)	%				1	
Flicker	dB				-20	

Note 1: Measurement method

The LCD module should be stabilized at given temperature for 0.5 hour to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 1 hour in a windless room.
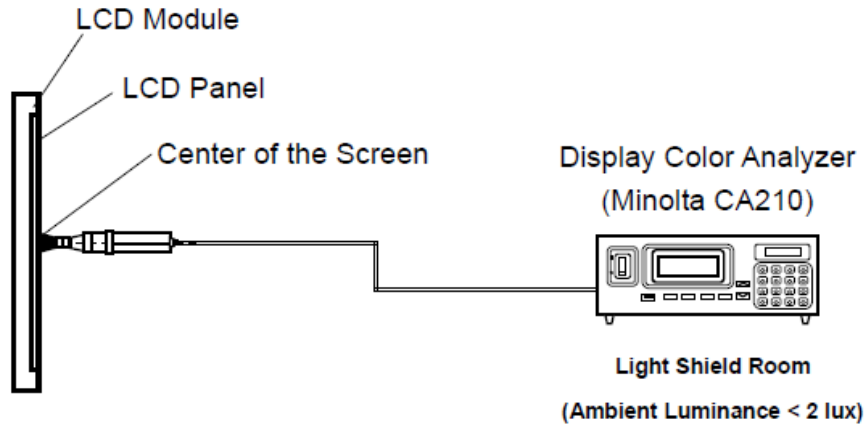

Note 2: Definition of viewing angle
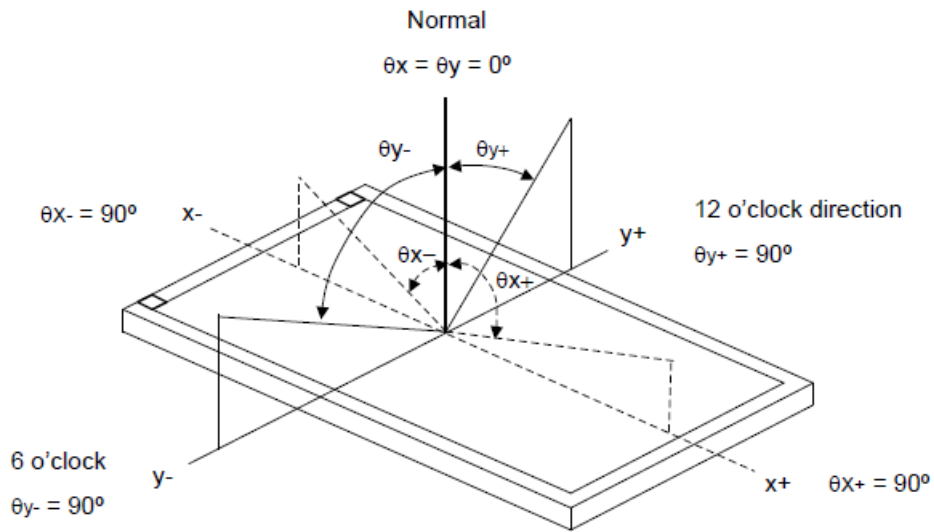
Note 3: Contrast ratio is measured by Topcon BM-7

Note 4: Definition of Response time

The output signals of photo detector are measured when the input signals are changed from "Full Black" to "Full White" (rising time), and from "Full White" to "Full Black" (falling time), respectively. The response time is interval between the 10% and 90% of amplitudes. Please refer to the figure as below.
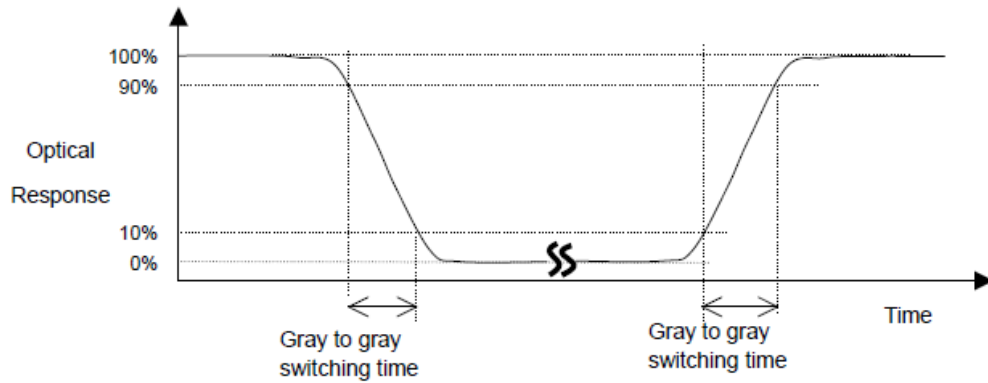
Note 5: Color chromaticity and coordinates (CIE) is measured by Topcon BM-7
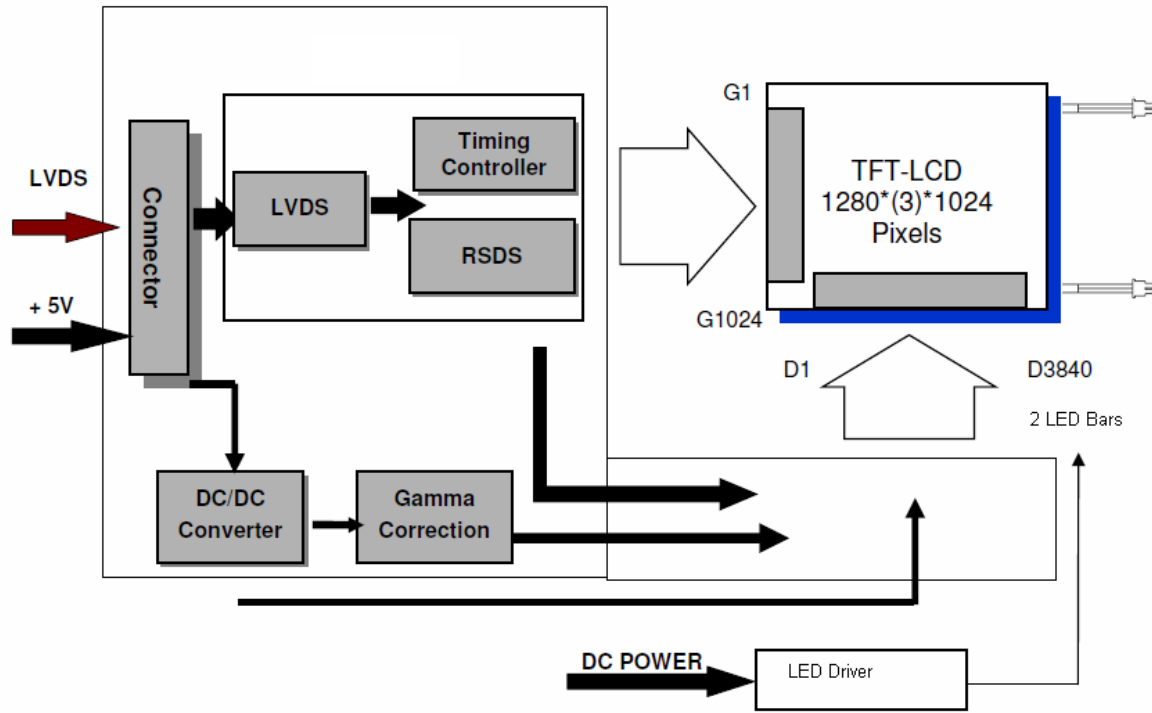
Note 6: Center luminance is measured by Topcon BM-7

Note 7: Luminance uniformity of these 5 points is defined as below and measured by Topcon BM-7
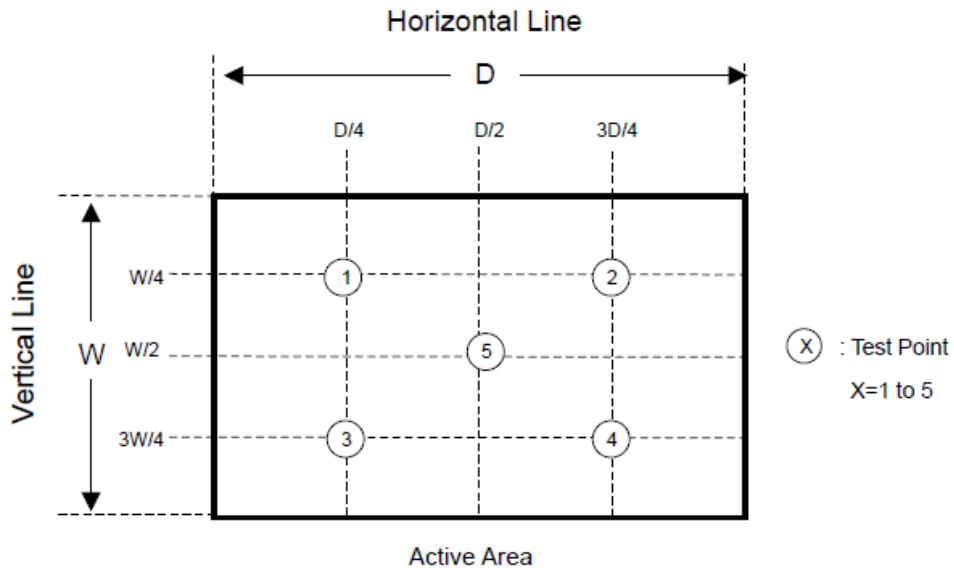
Uniformity = (Min. Luminance of 5 points) / (Max. Luminance of 5 points)

3. Functional Block Diagram

The following diagram shows the functional block of the 17 inches Color TFT-LCD Module:

I/F + X-PCB
JAE FI-XB30SSL-HF15

4. Absolute Maximum Ratings

Absolute maximum ratings of the module are as following:

4.1 TFT LCD Module

Items	Symbol	Min	Max	Unit	Conditions
Logic/ LCD drive voltage	Vin	-0.3	6	Volt	Note 1, 2

4.2 Backlight unit

Items	Symbol	Min	Max	Unit	Conditions
LED Current	I LED		640	mA	Note 1, 2

4.3 Absolute Ratings of Environment

Items	Symbol	Values			Unit	Conditions
		Min.	Typ.	Max.		
Operation temperature	T_{OP}	-20	-	50	^0C	
Operation Humidity	H_{OP}	8		90	%	Note 3, 4
Storage temperature	T_{ST}	-20		70	^0C	
Storage Humidity	H_{ST}	8		90	%	

Note 1: With in Ta= 25℃

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: For quality performance, please refer to IIS (Incoming Inspection Standard).

Note 4: Good thermal conductivity on top / bottom side of panel is necessary for high temperature operation.
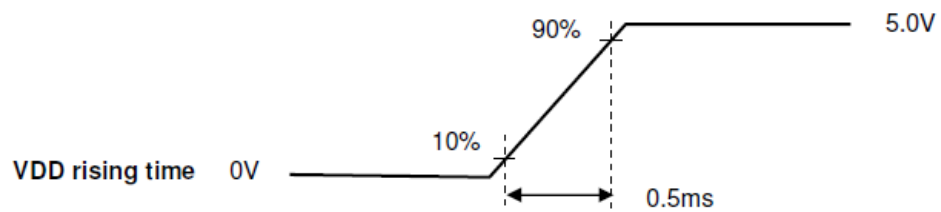
5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows

Symbol	Parameter	Min	Typ.	Max	Unit	Conditions
VCC	Logic/ LCD Drive Voltage	4.5	5.0	5.5	Volt	+/- 10%
ICC	Input current		1.25	1.38	A	VCC=5V, All black pattern.
PCC	VCC power		5.25		W	VCC=5V, All black pattern.
IRush	Inrush current			3	A	

Note: Measurement conditions:
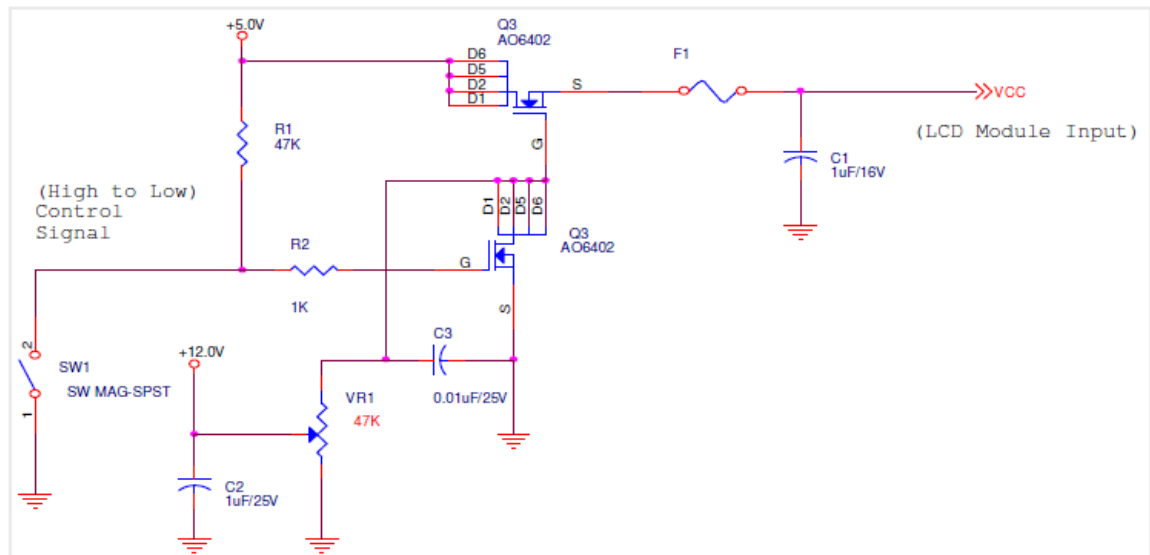
5.1.2 Signal Electrical Characteristics

Input signals shall be low or Hi-Z state when Vin is off

It is recommended to refer the specifications of SN75LVDS82DGG (Texas Instruments) in detail.

Characteristics of each signal are as following:

Symbol	Parameter	Min	Typ	Max	Unit	Condition
VTH	Differential Input High Threshold			+100	mV	VICM = 1.2V
VTL	Differential Input Low Threshold	-100			mV	VICM = 1.2V
VID	Input Differential Voltage	100	400	600	mV	
VICM	Differential Input Common Mode Voltage	+1.0	+1.2	+1.5	V	VTH/VTL = 100mV

Note: LVDS Signal Waveform.
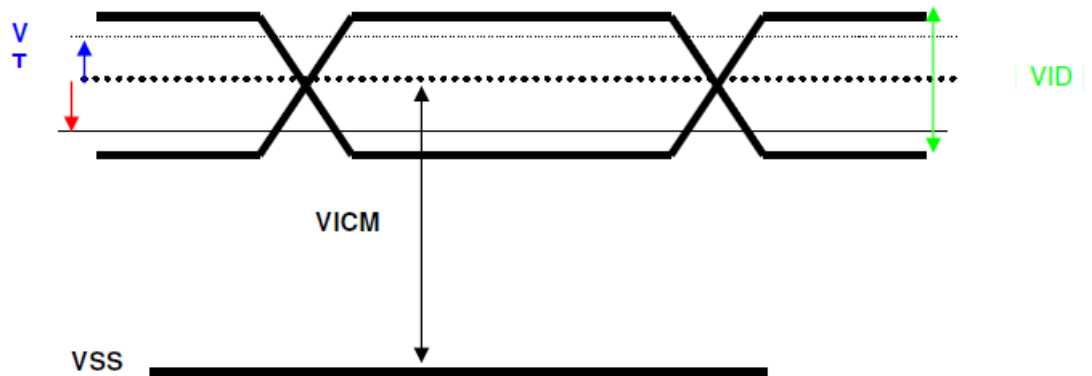
5.2 Backlight Unit

Parameter guideline is under stable conditions at 25℃ (Room Temperature):

Parameter	Min	Typ	Max	Unit	Note
LED voltage (VL)		29.7		[V]	2
LED current (IL)		540		[mA]	2, 3
LED Life Time(LTLED)		40,000		[Hour]	1

Note 1: The "LED life time" is defined as the module brightness decrease to 50% original brightness that the ambient temperature is 25℃ and typical LED Current at 360 mA .

Note 2: The LED driving condition is defined for each LED module.

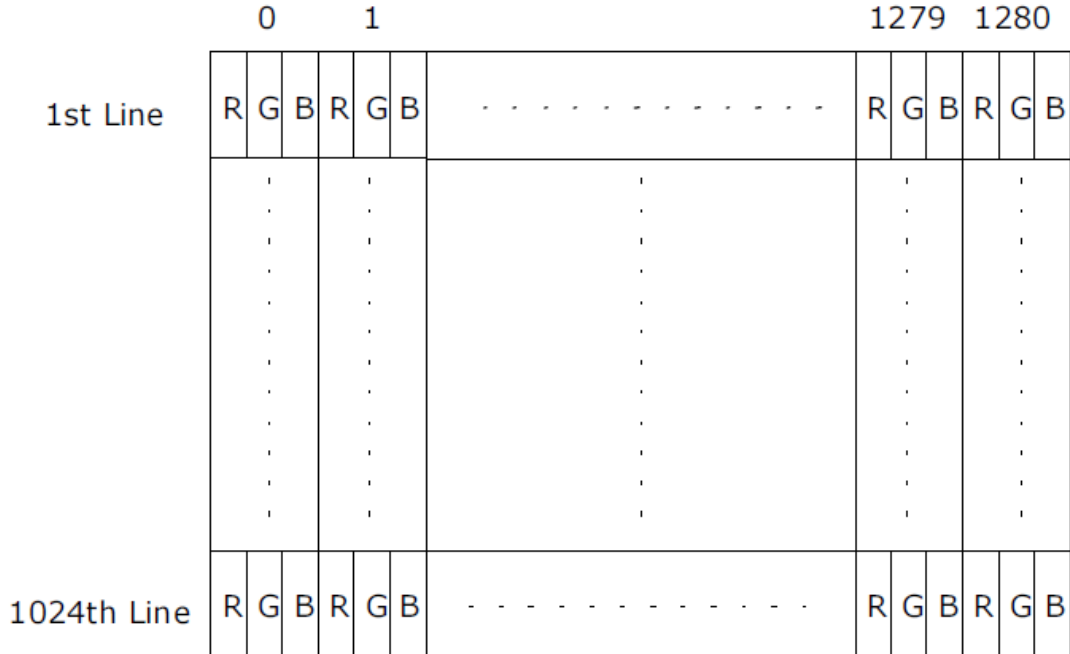Note 3: The variance of LED Light Bar power consumption is ±10%. Calculator value for reference (IL × VL × 2 = PLED)

Note 4: LED Light Bar Connector is used for the integral backlight system. The recommended model is BHSR-02VS-1 manufactured by JST
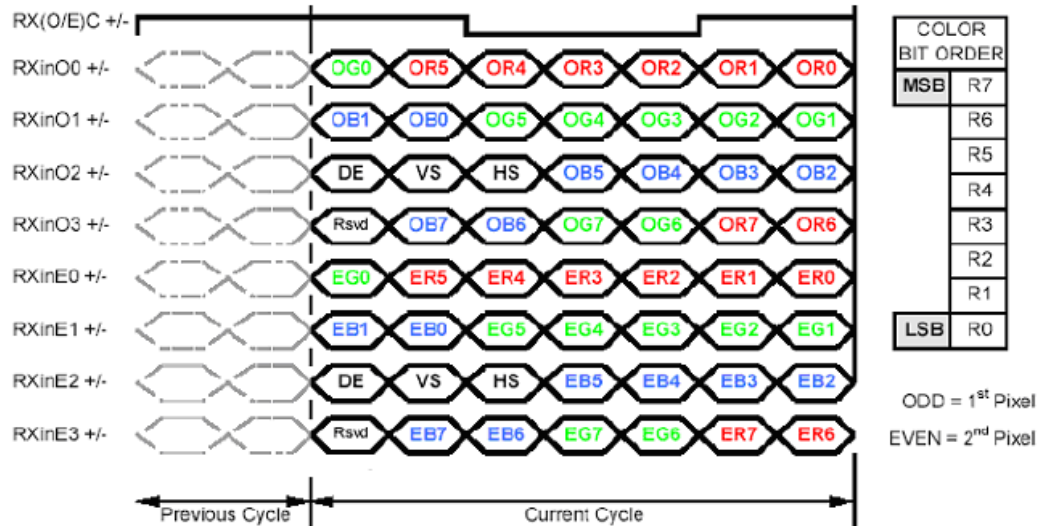
6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

6.2 The Input Data Format

Note1: Normally, DE, VS, HS on EVEN channel are not used.

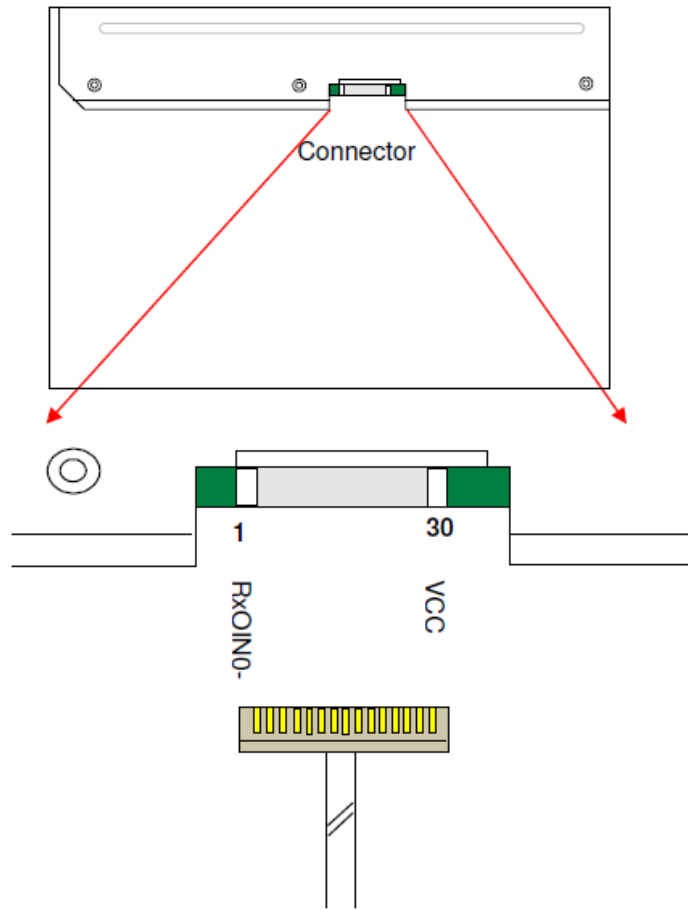Note2: Please follow PSWG.

Note3: 8-bit in

6.3 Signal Description

The module using a pair of LVDS receiver SN75LVDS82(Texas Instruments) or compatible. LVDS is a differential signal technology for LCD interface and high speed data transfer device. Transmitter shall be SN75LVDS83(negative edge sampling) or compatible. The first LVDS port(RxOxxx) transmits odd pixels while the second LVDS port(RxExxx) transmits even pixels..

PIN #	SIGNAL NAME	DESCRIPTION
1	RxO0-	Negative LVDS differential data input (Odd data)
2	RxO0+	Positive LVDS differential data input (Odd data)
3	RxO1-	Negative LVDS differential data input (Odd data)
4	RxO1+	Positive LVDS differential data input (Odd data)
5	RxO2-	Negative LVDS differential data input (Odd data, H-Sync,V-Sync,DSPTMG)
6	RxO2+	Positive LVDS differential data input (Odd data, H-Sync,V-Sync,DSPTMG)
7	GND	Power Ground
8	RxOC-	Negative LVDS differential clock input (Odd clock)
9	RxOC+	Positive LVDS differential clock input (Odd clock)
10	RxO3-	Negative LVDS differential data input (Odd data)
11	RxO3+	Positive LVDS differential data input (Odd data)
12	RxE0-	Negative LVDS differential data input (Even data)
13	RxE0+	Positive LVDS differential data input (Even data)
14	GND	Power Ground
15	RxE1-	Negative LVDS differential data input (Even data)
16	RxE1+	Positive LVDS differential data input (Even data)
17	GND	Power Ground
18	RxE2-	Negative LVDS differential data input (Even data)
19	RxE2+	Positive LVDS differential data input (Even data)
20	RxEC-	Negative LVDS differential clock input (Even clock)
21	RxEC+	Positive LVDS differential clock input (Even clock)
22	RxE3-	Negative LVDS differential data input (Even data)
23	RxE3+	Positive LVDS differential data input (Even data)
24	GND	Power Ground
25	GND	Power Ground (For AUO test Aging+HVS mode)
26	NC	No contact
27	GND	Power Ground
28	VCC	+5.0V Power Supply
29	VCC	+5.0V Power Supply
30	VCC	+5.0V Power Supply

Note1: Start from left side

Note2: Input signals of odd and even clock shall be the same timing.

Note3: Please follow PSWG.

6.4 Timing Characteristics

6.4.1 Timing Characteristics

Basically, interface timings described here is not actual input timing of LCD module but output timing of SN75LVDS82DGG (Texas Instruments) or equivalent.

| Signal	Item	Symbol	Min	Typ	Max	Unit
Vertical Section	Period	Tv	1034	1066	2048	Th
	Active	Tdisp(v)	1024	1024	1024	Th
	Blanking	Tbp(v)+Tfp(v)+PWvs	10	42	1024	Th
Horizontal Section	Period	Th	740	844	2048	Tclk
	Active	Tdisp(h)	640	640	640	Tclk
	Blanking	Tbp(h)+Tfp(h)+PWhs	100	204	1408	Tclk
Clock	Period	Tclk	14.81	18.52	-	ns
	Frequency	Freq	40	54	70	MHz
Frame rate	Frame rate	F	49	60	76	Hz

Note: DE mode.

6.4.2 Timing Diagram
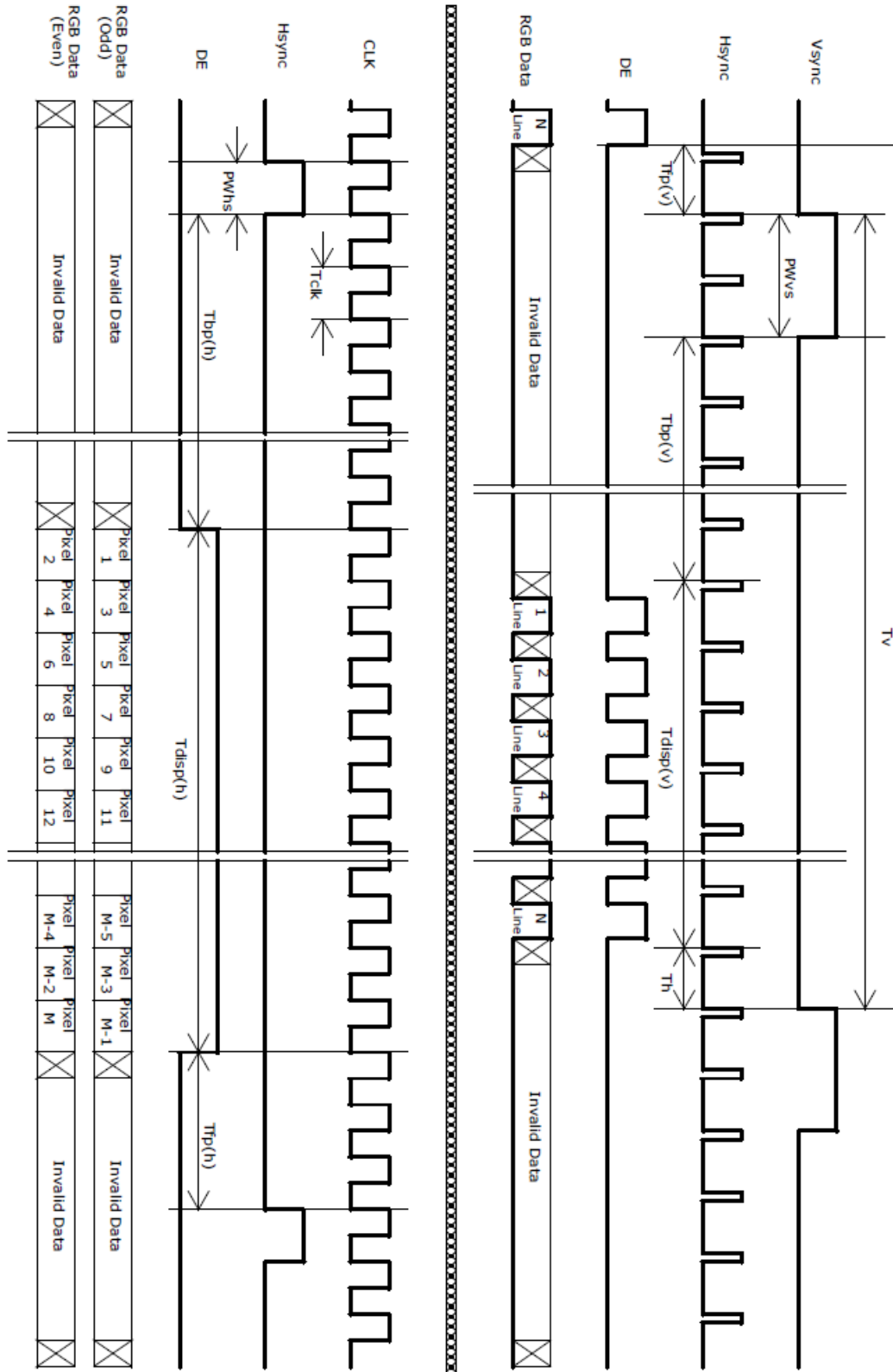
6.5 Power ON/OFF Sequence

VDD power and lamp on/off sequence is as below. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.
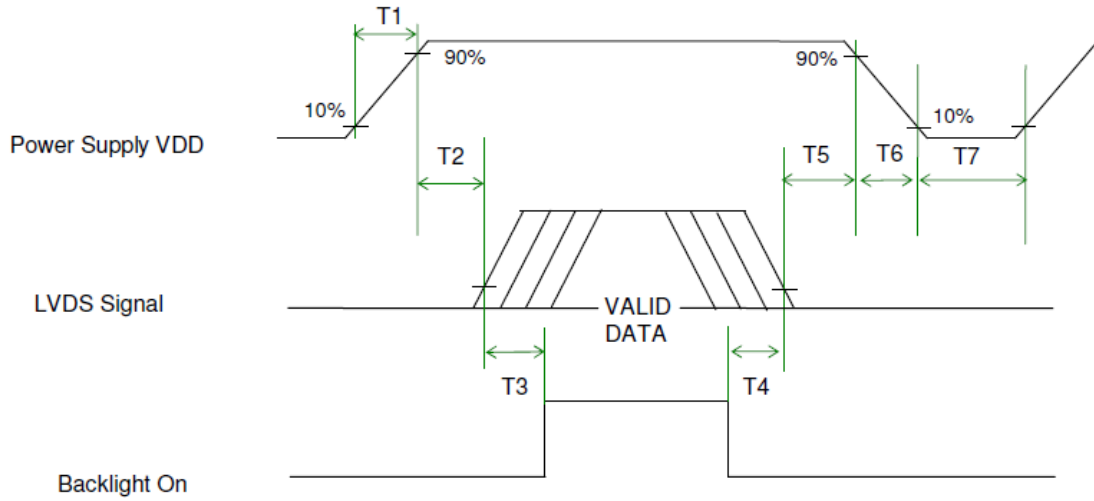
Power ON/OFF sequence timing

Parameter	Value			Unit
	Min.	Typ.	Max.	
T1	0.5	-	10	[ms]
T2	0	-	10	[ms]
T3	300	-	-	[ms]
T4	100	-	-	[ms]
T5	0	16	50	[ms]
T6	-	-	10	[ms]
T7	1000	-	-	[ms]

Note: The values of the table are follow PSWG.

7.0 Connector & Pin Assignment

Physical interface is described as for the connector on module. These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

7.1.1 Connector

Connector Name / Designation	Interface Connector / Interface card
Manufacturer	JAE / STM or compatible
Type Part Number	FI-XB30SSL-HF15 / MSBKT2407P30HB
Mating Housing Part Number	JAE FI-X30HL

7.1.2 Pin Assignment

Pin#	Signal Name	Pin#	Signal Name
1	RxOIN0-	2	RxOIN0+
3	RxOIN1-	4	RxOIN1+
5	RxOIN2-	6	RxOIN2+
7	GND	8	RxOCLKIN-
9	RxOCLKIN+	10	RxOIN3-
11	RxOIN3+	12	RxEIN0-
13	RxEIN0+	14	GND
15	RxEIN1-	16	RxEIN1+
17	GND	18	RxEIN2-
19	RxEIN2+	20	RxECLKIN-
21	RxECLKIN+	22	RxEIN3-
23	RxEIN3+	24	GND
25	NC	26	NC
27	NC	28	VCC
29	VCC	30	VCC

7.2 Backlight Unit: LED Connector

Pin No.	Symbol	I/O	Function	Remark
1	VLED+	P	Power for LED backlight anode	White
2	VLED-	P	Power for LED backlight cathode	Black

LED Light Bar Connector is used for the integral backlight system. The recommended model is BHSR-02VS-1 manufactured by JST.

8. Reliability Test

Environment test conditions are listed as following table.

Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50℃, 80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50℃, 50%RH, 300hours	3
Low Temperature Operation (LTO)	Ta= -20℃, 300hours	
High Temperature Storage (HTS)	Ta= 70℃, 300hours	
Low Temperature Storage (LTS)	Ta= -20℃, 300hours	
Drop Test	Height: 60 cm, package test	
Thermal Shock Test (TST)	-20℃/30min, 60℃/30min, 100 cycles	1
On/Off Test	On/10sec, Off/10sec, 30,000 cycles	
ESD (ElectroStatic Discharge)	Contact Discharge: ± 8KV, 150pF(330Ω) 1sec, 9 points, 25 times/ point.	2
	Air Discharge: ± 15KV, 150pF(330Ω) 1sec 9 points, 25 times/ point.	2

Note 1: The TFT-LCD module will not sustain damage after being subjected to 100 cycles of rapid temperature change. A cycle of rapid temperature change consists of varying the temperature from -20℃ to 60℃, and back again. Power is not applied during the test. After temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 2: According to EN61000-4-2 , ESD class B: Some performance degradation allowed. No data lost. Self-recoverable. No hardware failures.

Note 3: The test items are tested by open frame type chassis.

9. Shipping Label & Package
(TBD)

(Original panel package)

10. Mechanical Characteristic